

## PRODUCT DATASHEET RGBX series

last update 5/2/2013



1500	Ordering number	CP10960_RGBX-SS		
	Family Type LED Color	RGBX Assembly Ostar-SMT RGB Black	FWHM Efficiency cd/Im Gerber File	18 degrees 85 % 4.400 Available
	Diameter Height Style Optic Material Holder Material	30 mm 28 mm Round PMMA PC		, manual o
	Fastening Status Ordering number	Glue Ready CP10766_RGBX-M		
	Family Type LED Color Diameter Height Style	RGBX Assembly Ostar-SMT RGB Black 30 mm 28 mm Round	FWHM Efficiency cd/lm Gerber File	30 degrees 70 % - Available
	Optic Material Holder Material Fastening Status	PMMA PC Glue Ready CP10767_RGBX-O		
	Family Type LED Color Diameter Height	RGBX Assembly Ostar-SMT RGB Black 30 mm 28 mm Round	FWHM Efficiency cd/lm Gerber File	50+33 degrees 69 % - Available
	Style Optic Material Holder Material Fastening Status	PMMA PC Glue Ready		

NOTE: The typical divergence will be changed by different color, chip size and chip position tolerance. The typical total divergence is the full angle measured where the luminous intensity is half of the peak value.



PRODUCT DATASHEET RGBX series last update 5/2/2013



## **GENERAL INFORMATION**

- Product series especially designed & optimized for Ostar-SMT RGB series of LEDs.

- Special care taken to make light distribution as uniform as possible.

- Lens material optical grade PMMA with high UV and temperature resistance. Allows use of high current and temperature conditions.

Please find more information about used material from below:

http://ledil.fi/sites/default/files/Documents/Technical/Material/PMMA%208N%20UL94\_Yellow%20Card.pdf http://ledil.fi/sites/default/files/Documents/Technical/Material/PMMA%208N%20PLEXIGLAS-Datasheet.pdf - Optic holder molded by high quality PC material (120 dergees of Celcius / 248 degrees of Fahrenheit).

- Fastening to PCB with appropriate adhesive. By clicking link below you can find Ledil recommended glue options.

http://www.ledil.com/datasheets/DataSheet\_GLUES.pdf

NOTE 1: We advise customer to ensure the suitability and sufficiency of the bond in the end product. For example, mechanical stress, vibration and holes on the surface of the circuit boar weaken the strength of the glue.

NOTE 2: All surfaces where glue is applied must be clean, dry and free from grease and dirt. If cleaning of PCB surfaces is needed, please follow strictly the cleaning instructions of your LED manufacturer -this is important as cleaning shall under no circumstances damage LEDs or other electronics components on the PCB.

Further note that optical components shall not be cleaned with any chemicals - only micro fiber cloth may be used to remove fingerprints or other traces from handling.